

Product Preview

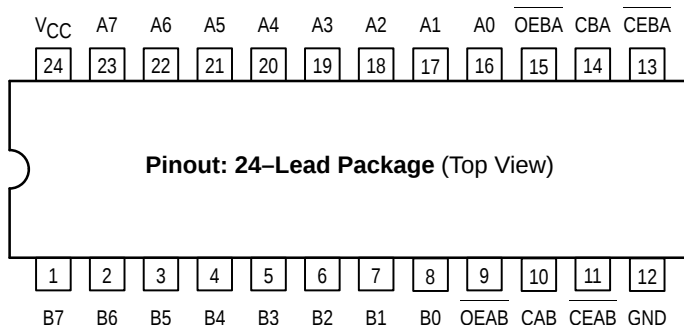
Low-Voltage CMOS Octal Registered Transceiver With Dual Output and Clock Enables

With 5V-Tolerant Inputs and Outputs (3-State, Non-Inverting)

The MC74LCX2952 is a high performance, non-inverting octal registered transceiver operating from a 2.7 to 3.6V supply. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A V_I specification of 5.5V allows MC74LCX2952 inputs to be safely driven from 5V devices. The MC74LCX2952 is suitable for memory address driving and all TTL level bus oriented transceiver applications.

Two 8-bit back to back registers store data from either of two bidirectional buses. Data applied to the inputs is entered and stored on the rising edge of the Clock (CAB, CBA) provided that the Clock Enable (CEAB, CEBA) is Low. The data is then presented at the 3-state output buffers, but is only accessible when the Output Enable (OEAB, OEBA) is Low. The operation of the MC74LCX2952 is symmetrical — A inputs to B outputs occurs in the same manner as B inputs to A outputs.

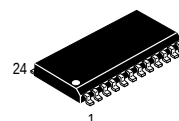
- Designed for 2.7 to 3.6V V_{CC} Operation
- 5V Tolerant — Interface Capability With 5V TTL Logic
- Supports Live Insertion and Withdrawal
- I_{OFF} Specification Guarantees High Impedance When $V_{CC} = 0V$
- LVTTTL Compatible
- LVC MOS Compatible
- 24mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current in All Three Logic States (10 μ A) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500mA
- ESD Performance: Human Body Model >2000V; Machine Model >200V



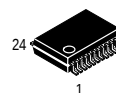
MC74LCX2952

LCX

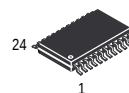
LOW-VOLTAGE CMOS
OCTAL REGISTERED
TRANSCIVER



DW SUFFIX
PLASTIC SOIC
CASE 751E-04



SD SUFFIX
PLASTIC SSOP
CASE 940D-03



DT SUFFIX
PLASTIC TSSOP
CASE 948H-01

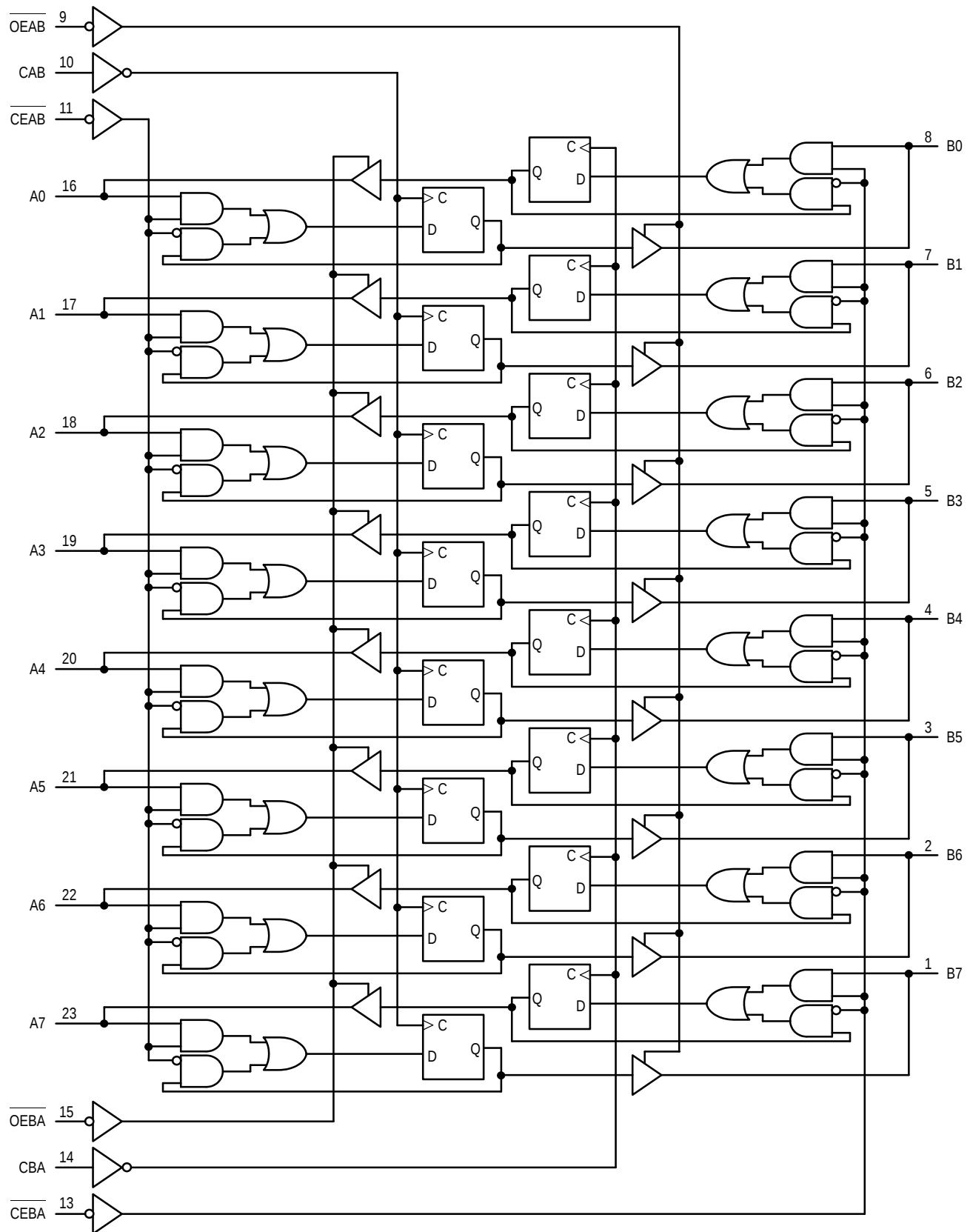
PIN NAMES

Pins	Function
A0–A7 B0–B7	Side A Inputs/Outputs Side B Inputs/Outputs
CAB, CBA	Clock Pulse Inputs
CEAB, CEBA	Clock Enable Inputs
OEAB, OEBA	Output Enable Inputs

This document contains information on a product under development. Motorola reserves the right to change or discontinue this product without notice.



LOGIC DIAGRAM



FUNCTION TABLE

Inputs								Internal Register		Outputs		Operating Mode
An	OEAB	CEAB	CAB	Bn	OEBA	CEBA	CBA	QABn	QBAn	An	Bn	
h l	L L	l l	↑ ↑	U U	H H	X X	X X	H L	X X	NA NA	H L	Load A to B Register; Read B Output
X	L	h	X	U	H	X	X	NC	X	NA	NC	Hold; Read B Output
h l	H H	l l	↑ ↑	X X	H H	X X	X X	H L	X X	NA NA	Z Z	Load A to B Register; Disable B Outputs
X	H	h	X	X	H	X	X	NC	X	NA	Z	Hold; Disable B Outputs
U U	H H	X X	X X	h l	L L	l l	↑ ↑	X X	H L	H L	NA NA	Load B to A Register; Read A Output
U	H	X	X	X	L	h	X	X	NC	NC	NA	Hold; Read A Output
X X	H H	X X	X X	h l	H H	l l	↑ ↑	X X	H L	Z Z	NA NA	Load B to A Register; Disable A Outputs
X	H	X	X	X	H	h	X	X	NC	Z	NA	Hold; Disable A Outputs

H = High Voltage Level; h = High Voltage Level One Setup Time Prior to Clock Low-to-High Transition; L = Low Voltage Level; l = Low Voltage Level One Setup Time Prior to Clock Low-to-High Transition; NA = Not Applicable; U = Undriven; Z = High Impedance State; X = Don't Care; NC = No Change; ↑ = Low-to-High Transition

ABSOLUTE MAXIMUM RATINGS*

Symbol	Parameter	Value	Condition	Unit
V _{CC}	DC Supply Voltage	−0.5 to +7.0		V
V _I	DC Input Voltage	−0.5 ≤ V _I ≤ +7.0		V
V _O	DC Output Voltage	−0.5 ≤ V _O ≤ +7.0	Output in 3-State	V
		−0.5 ≤ V _O ≤ V _{CC} + 0.5 ¹	Output in HIGH or LOW State	V
I _{IK}	DC Input Diode Current	−50	V _I < GND	mA
I _{OK}	DC Output Diode Current	−50	V _O < GND	mA
		+50	V _O > V _{CC}	mA
I _O	DC Output Source/Sink Current	±50		mA
I _{CC}	DC Supply Current Per Supply Pin	±100		mA
I _{GND}	DC Ground Current Per Ground Pin	±100		mA
T _{STG}	Storage Temperature Range	−65 to +150		°C

* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

1. I_O absolute maximum rating must be observed.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit
V_{CC}	Supply Voltage Operating Data Retention Only	2.0 1.5	3.3 3.3	3.6 3.6	V
V_I	Input Voltage	0		5.5	V
V_O	Output Voltage (HIGH or LOW State) (3-State)	0 0		V_{CC} 5.5	V
I_{OH}	HIGH Level Output Current, $V_{CC} = 3.0V - 3.6V$			-24	mA
I_{OL}	LOW Level Output Current, $V_{CC} = 3.0V - 3.6V$			24	mA
I_{OH}	HIGH Level Output Current, $V_{CC} = 2.7V - 3.0V$			-12	mA
I_{OL}	LOW Level Output Current, $V_{CC} = 2.7V - 3.0V$			12	mA
T_A	Operating Free-Air Temperature	-40		+85	°C
$\Delta t/\Delta V$	Input Transition Rise or Fall Rate, V_{IN} from 0.8V to 2.0V, $V_{CC} = 3.0V$	0		10	ns/V

DC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Condition	$T_A = -40^\circ\text{C to } +85^\circ\text{C}$		Unit
			Min	Max	
V_{IH}	HIGH Level Input Voltage (Note 1)	$2.7V \leq V_{CC} \leq 3.6V$	2.0		V
V_{IL}	LOW Level Input Voltage (Note 1)	$2.7V \leq V_{CC} \leq 3.6V$		0.8	V
V_{OH}	HIGH Level Output Voltage	$2.7V \leq V_{CC} \leq 3.6V$; $I_{OH} = -100\mu A$	$V_{CC} - 0.2$		V
		$V_{CC} = 2.7V$; $I_{OH} = -12mA$	2.2		
		$V_{CC} = 3.0V$; $I_{OH} = -18mA$	2.4		
		$V_{CC} = 3.0V$; $I_{OH} = -24mA$	2.2		
V_{OL}	LOW Level Output Voltage	$2.7V \leq V_{CC} \leq 3.6V$; $I_{OL} = 100\mu A$		0.2	V
		$V_{CC} = 2.7V$; $I_{OL} = 12mA$		0.4	
		$V_{CC} = 3.0V$; $I_{OL} = 16mA$		0.4	
		$V_{CC} = 3.0V$; $I_{OL} = 24mA$		0.55	
I_I	Input Leakage Current	$2.7V \leq V_{CC} \leq 3.6V$; $0V \leq V_I \leq 5.5V$		± 5.0	μA
I_{OZ}	3-State Output Current	$2.7 \leq V_{CC} \leq 3.6V$; $0V \leq V_O \leq 5.5V$; $V_I = V_{IH}$ or V_{IL}		± 5.0	μA
I_{OFF}	Power-Off Leakage Current	$V_{CC} = 0V$; V_I or $V_O = 5.5V$		10	μA
I_{CC}	Quiescent Supply Current	$2.7 \leq V_{CC} \leq 3.6V$; $V_I = GND$ or V_{CC}		10	μA
		$2.7 \leq V_{CC} \leq 3.6V$; $3.6 \leq V_I$ or $V_O \leq 5.5V$		± 10	μA
ΔI_{CC}	Increase in I_{CC} per Input	$2.7 \leq V_{CC} \leq 3.6V$; $V_{IH} = V_{CC} - 0.6V$		500	μA

1. These values of V_I are used to test DC electrical characteristics only. Functional test should use $V_{IH} \geq 2.4V$, $V_{IL} \leq 0.5V$.

AC CHARACTERISTICS ($t_R = t_F = 2.5\text{ns}$; $C_L = 50\text{pF}$; $R_L = 500\Omega$)

Symbol	Parameter	Waveform	Limits				Unit
			T _A = −40°C to +85°C				
			V _{CC} = 3.0V to 3.6V		V _{CC} = 2.7V		
			Min	Max	Min	Max	
f _{max}	Clock Pulse Frequency	3	150				MHz
t _{PLH} t _{PHL}	Propagation Delay Clock to Output	1	1.5 1.5	8.5 8.5	1.5 1.5	9.5 9.5	ns
t _{PZH} t _{PZL}	Output Enable Time to High and Low Level	2	1.5 1.5	8.5 8.5	1.5 1.5	9.5 9.5	ns
t _{PHZ} t _{PLZ}	Output Disable Time From High and Low Level	2	1.5 1.5	8.5 8.5	1.5 1.5	9.5 9.5	ns
t _S	Setup Time, HIGH to LOW Data to Clock	3	2.5		2.5		ns
t _H	Hold Time, HIGH to LOW Data to Clock	3	1.5		1.5		ns
t _S	Setup Time, HIGH to LOW CE _{xx} to Clock	3	2.5		2.5		ns
t _H	Hold Time, HIGH to LOW CE _{xx} to Clock	3	1.5		1.5		ns
t _W	Clock Pulse Width, HIGH or LOW	3	3.3		3.3		ns
t _{OSHL} t _{OSLH}	Output-to-Output Skew (Note 2)			1.0 1.0			ns

1. These AC parameters are preliminary and may be modified prior to release. The maximum AC limits are design targets. Actual performance will be specified upon completion of characterization.
2. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

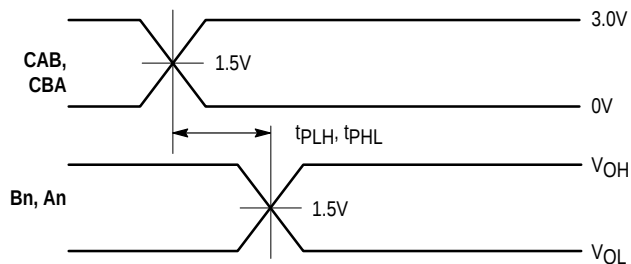
DYNAMIC SWITCHING CHARACTERISTICS

Symbol	Characteristic	Condition	$T_A = +25^\circ\text{C}$			Unit
			Min	Typ	Max	
V_{OLP}	Dynamic LOW Peak Voltage ¹	$V_{CC} = 3.3\text{V}$, $C_L = 50\text{pF}$, $V_{IH} = 3.3\text{V}$, $V_{IL} = 0\text{V}$		0.8		V
V_{OLV}	Dynamic LOW Valley Voltage ¹	$V_{CC} = 3.3\text{V}$, $C_L = 50\text{pF}$, $V_{IH} = 3.3\text{V}$, $V_{IL} = 0\text{V}$		0.8		V

1. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

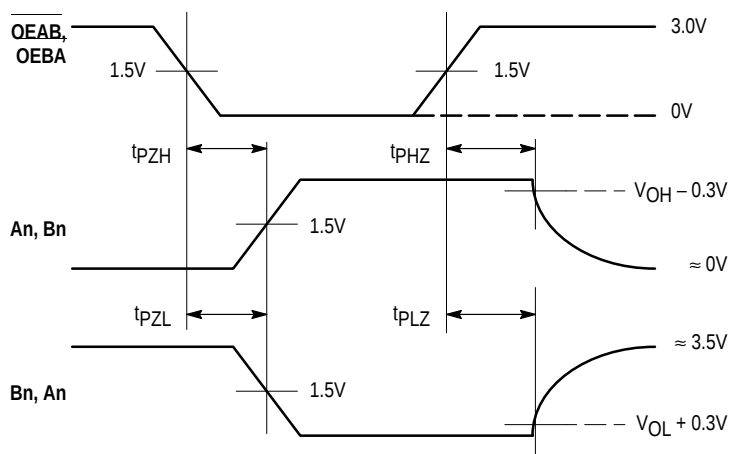
CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
CPD	Power Dissipation Capacitance	10MHz, $V_{CC} = 3.3\text{V}$, $V_I = 0\text{V}$ or V_{CC}	25	pF
C_{IN}	Input Capacitance	$V_{CC} = 3.3\text{V}$, $V_I = 0\text{V}$ or V_{CC}	7	pF
$C_{\text{I/O}}$	Input/Output Capacitance	$V_{CC} = 3.3\text{V}$, $V_I = 0\text{V}$ or V_{CC}	8	pF



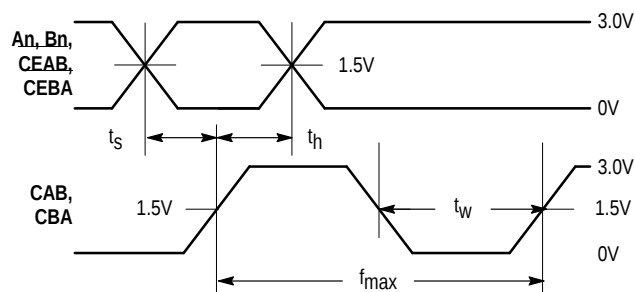
WAVEFORM 1 – Cxx to An/Bn PROPAGATION DELAYS

$t_R = t_F = 2.5\text{ns}$, 10% to 90%; $f = 1\text{MHz}$; $t_W = 500\text{ns}$



WAVEFORM 2 – OExx to An/Bn OUTPUT ENABLE AND DISABLE TIMES

$t_R = t_F = 2.5\text{ns}$, 10% to 90%; $f = 1\text{MHz}$; $t_W = 500\text{ns}$



WAVEFORM 3 – Cxx MINIMUM PULSE WIDTH, An/Bn/CExx to Cxx SETUP AND HOLD TIMES

$t_R = t_F = 2.5\text{ns}$, 10% to 90%; $f = 1\text{MHz}$; $t_W = 500\text{ns}$ except when noted

Figure 1. AC Waveforms

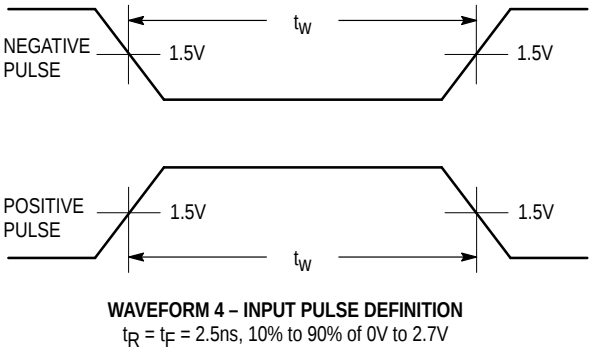


Figure 2. AC Waveforms

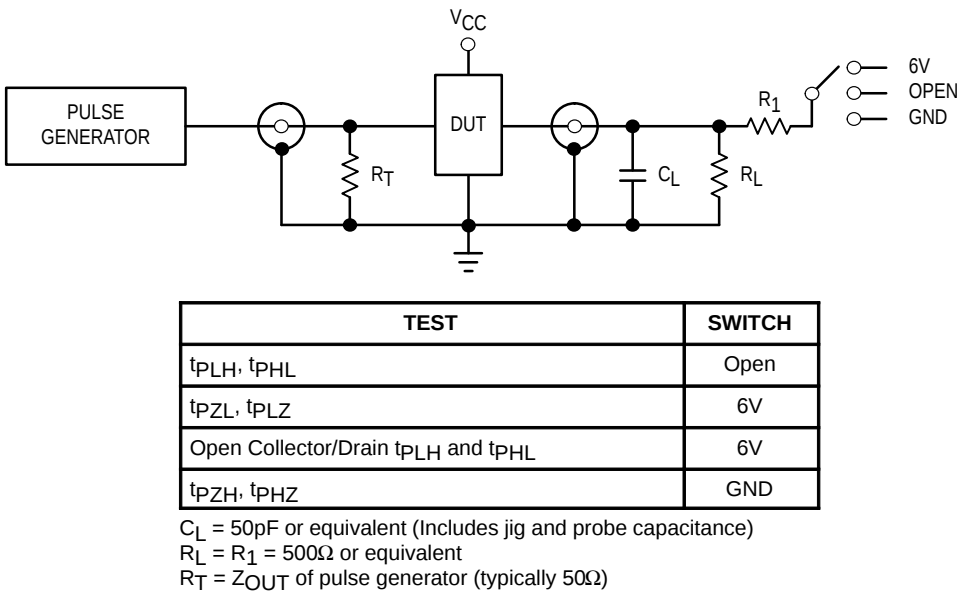
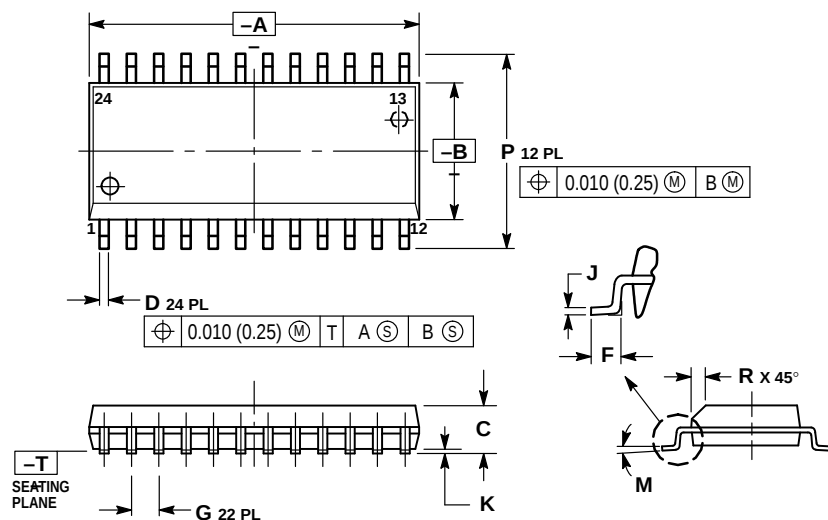


Figure 3. Test Circuit

OUTLINE DIMENSIONS

DW SUFFIX
PLASTIC SOIC PACKAGE
CASE 751E-04
ISSUE E

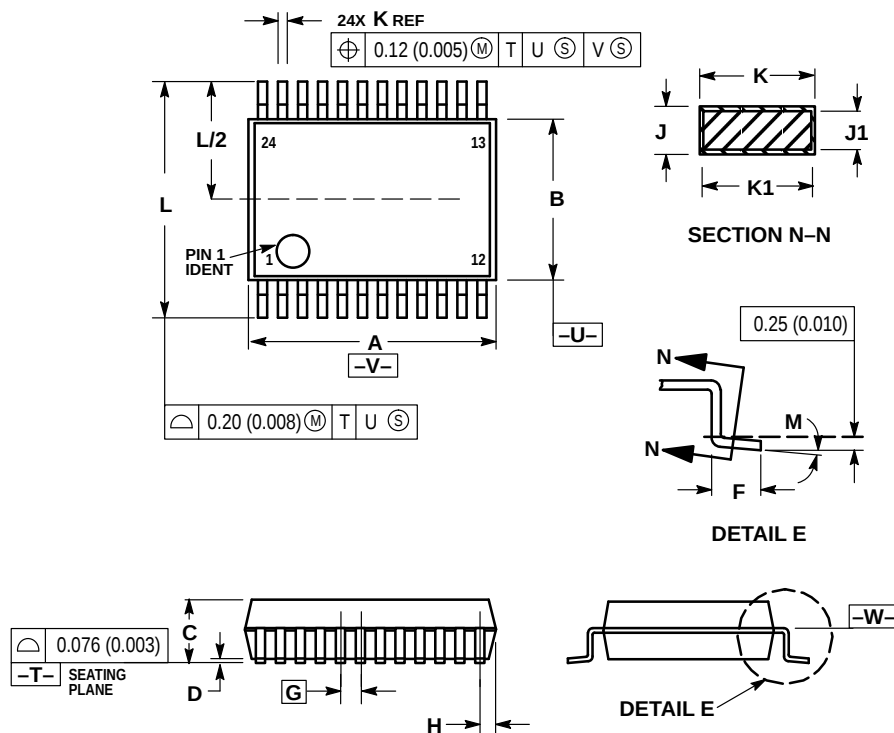


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	15.25	15.54	0.601	0.612
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.41	0.90	0.016	0.035
G	1.27 BSC		0.050 BSC	
J	0.23	0.32	0.009	0.013
K	0.13	0.29	0.005	0.011
M	0°	8°	0°	8°
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

SD SUFFIX
PLASTIC SSOP PACKAGE
CASE 940D-03
ISSUE B



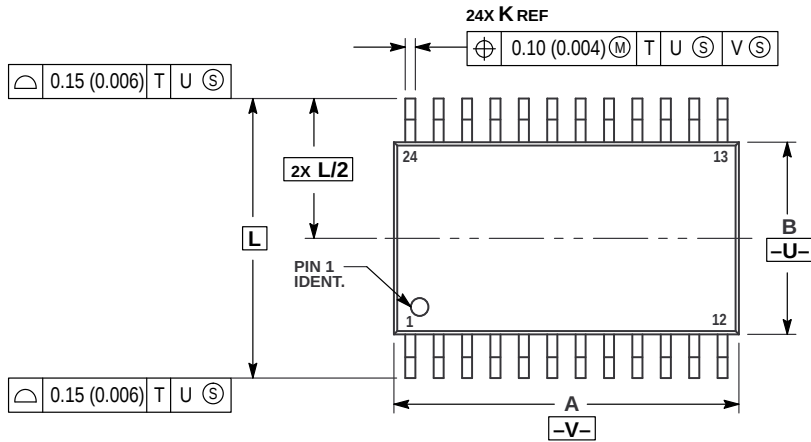
NOTES:

4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
5. CONTROLLING DIMENSION: MILLIMETER.
6. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
7. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
8. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION/INTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF K DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR INTRUSION SHALL NOT REDUCE DIMENSION K BY MORE THAN 0.07 (0.002) AT LEAST MATERIAL CONDITION.
9. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
10. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.07	8.33	0.317	0.328
B	5.20	5.38	0.205	0.212
C	1.73	1.99	0.068	0.078
D	0.05	0.21	0.002	0.008
F	0.63	0.95	0.024	0.037
G	0.65 BSC		0.026 BSC	
H	0.44	0.60	0.017	0.024
J	0.09	0.20	0.003	0.008
J1	0.09	0.16	0.003	0.006
K	0.25	0.38	0.010	0.015
K1	0.25	0.33	0.010	0.013
L	7.65	7.90	0.301	0.311
M	0°	8°	0°	8°

OUTLINE DIMENSIONS

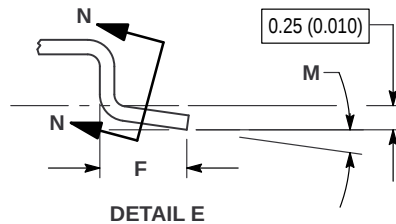
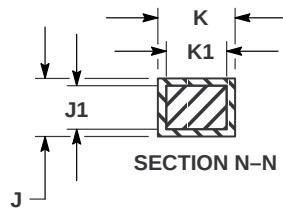
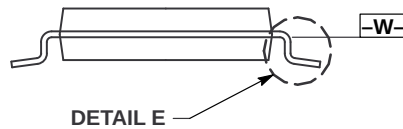
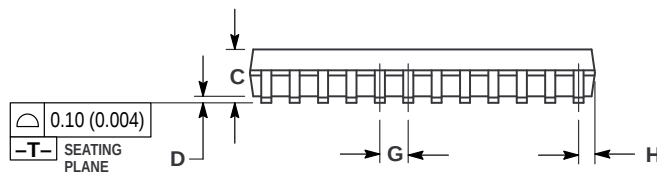
DT SUFFIX
PLASTIC TSSOP PACKAGE
CASE 948H-01
ISSUE O



NOTES:

- 1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2 CONTROLLING DIMENSION: MILLIMETER.
- 3 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
- 4 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
- 5 DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 6 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- 7 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.70	7.90	0.303	0.311
B	4.30	4.50	0.169	0.177
C	—	1.20	—	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°



Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters can and do vary in different applications. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part. Motorola and  are registered trademarks of Motorola, Inc. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

How to reach us:

USA/EUROPE: Motorola Literature Distribution;
P.O. Box 20912; Phoenix, Arizona 85036. 1-800-441-2447

MFAX: RMFAX0@email.sps.mot.com -TOUCHTONE (602) 244-6609
INTERNET: <http://Design-NET.com>

JAPAN: Nippon Motorola Ltd.; Tatsumi-SPD-JLDC, Toshikatsu Otsuki,
6F Seibu-Butsuryu-Center, 3-14-2 Tatsumi Koto-Ku, Tokyo 135, Japan. 03-3521-8315

HONG KONG: Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park,
51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298



◇ CODELINE

MC74LCX2952/D

